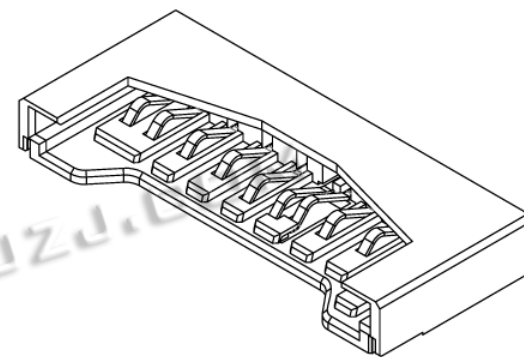
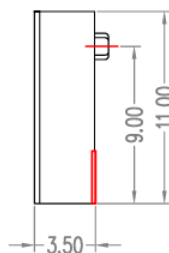
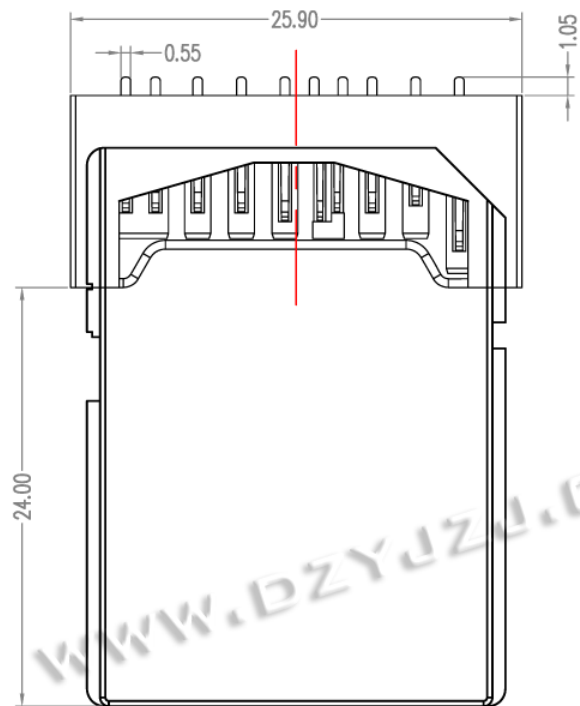
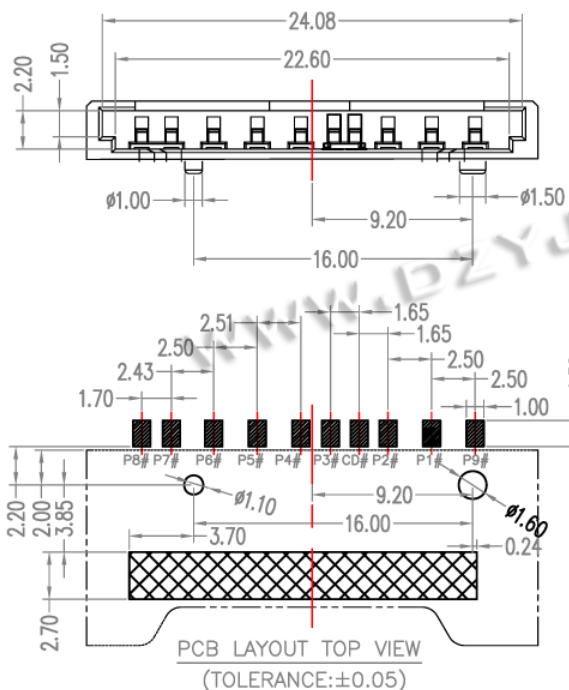




3D VIEW

SD CARD PIN DESIGN			
Pin#	Name	Type	Card Detect/ Data Line Bit31
1	CD/DAT3	I/O/PP	Command/Response
2	CMD	PP	Supply voltage
3	Vss1	S	Supply voltage ground
4	VDD	S	Supply voltage
5	CLK	I	Clock
6	Vss2	S	Supply voltage ground
7	DAT0	I/O/PP	Date Line [Bit0]
8	DAT1	I/O/PP	Date Line [Bit1]
9	DAT2	I/O/PP	Date Line [Bit2]



Pad Area
 Keep Out Area

SPECIFICATION

1.ELECTRICAL CHARACTERISTICS:

CONTACT CURRENT RATING:0.5 AMPERES.
 DIELECTRIC WITHSTANDING VOLTAGE:AC500VR.M.S.
 INSULATION RESISTANCE:1000M Ω MINIMUM.
 CONTACT RESISTANCE:40M Ω MAXIMUM.

2.ENVIRONMENTAL:

OPERATING TEMPERATURE:-20 $^{\circ}$ C~+85 $^{\circ}$ C.

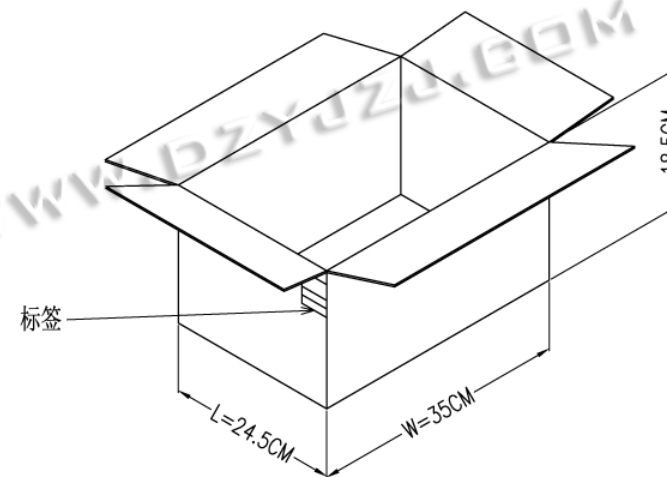
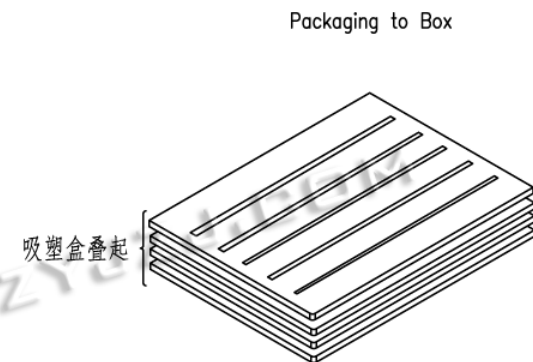
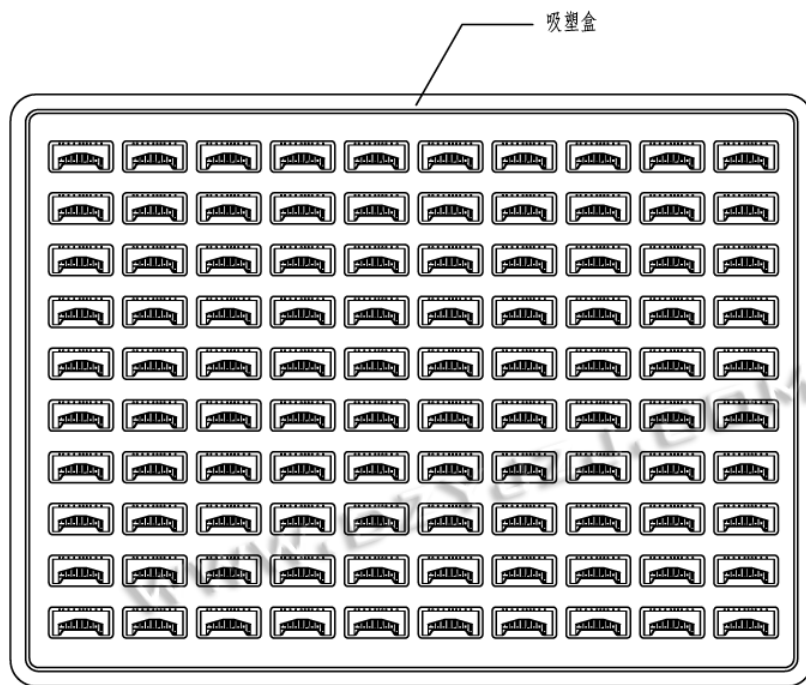
3.MATERIAL:

HOUSING:H1-TEMP PLASTIC LCP UL 94V-0 RATED
 CONTACT:COPPER ALLOY(T=0.20MM).



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ± 0.30 X.XX ± 0.25 X.XXX ± 0.15 X' $\pm 2^{\circ}$ X.X' $\pm 0.5^{\circ}$	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: SD简易全塑	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HVC31-SD11-259	MOLD NO.
UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO: HVC-SD15082016	SHEET NO. 1 OF 1



1. 材质要求:

1.1 纸箱材质:A=B; 尺寸:35*24.5*18.5CM;

2. 包装要求:

2.1 将装好产品的吸塑盒重叠叠起, 每叠30盘分别用PE膜缠绕好捆成一捆, 按统一方向放入纸箱, 并在纸箱内放置干燥剂

2.2 把包装好的成品用胶纸打包封箱, 并在纸箱外贴上标签

3. 包装数量: 30盘 x 100PCS/盘 = 3000 PCS/箱



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 包装图	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	
			SHEET NO.	1 OF 1